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These assemblies are ESD sensitive, ESD precautions shall be observed.

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Label Table

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PCB Number: TIDA-01051
PCB Rev: E1

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PCB
LOGO
Pb-Free Symbol

Assembly Notes

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